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PTO/SB/01 (10-00)

Approved for use through 10/31/2002. OMB 0651-0032

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				Attorney Docket Numbe	r 576P043			
			OR UTILITY OR	First Named Inventor	Shoji OISO			
	DESIGN PATENT APPLICATION (37 CFR 1.63)			COMPLETE IF KNOWN				
				Application Number				
	-			Filing Date				
	☑ Declaration Submitted with Initial Filing	Declaration OR Submitted after Initial Filing (surcharge (37 CFR 1.16 (e)) required)	Group Art Unit					
			Examiner Name	·				

in-part applications, material information which became available between the filling date of the prior application and the national of											
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: DYE TYPE POLARIZING PLATE	As a below named inventor, I hereby declare that:										
names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: DYE TYPE POLARIZING PLATE (Title of the Invention) the specification of which is attached hereto OR was filed on (MM/DD/YYYY) Application Number PCT/JP00/04658 and was amended on (MM/DD/YYYY) I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation in-part applications, material information which became available between the filing date of the prior application and the national or	My residence, mailing address, and citizenship are as stated below next to my name.										
the specification of which is attached hereto OR was filed on (MM/DD/YYYY) July 12,2000 Application Number PCT/JP00/04658 and was amended on (MM/DD/YYYY) I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation in-part applications, material information which became available between the filing date of the prior application and the national or	I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:										
the specification of which is attached hereto OR as United States Application Number or PCT International Was filed on (MM/DD/YYYY) Application Number PCT/JP00/04658 and was amended on (MM/DD/YYYY) I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation in-part applications, material information which became available between the filing date of the prior application and the national or	DYE TYPE POLARIZING PLATE										
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I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation in-part applications, material information which became available between the filing date of the prior application and the national or											
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PCT international filing date of the continuation-in-part application.	I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.										
I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application having a filing date before that of the application on which priority is claimed.											
Prior Foreign Application Number(s) Prior Foreign Filing Date Priority Certified Copy Attached? (MM/DD/YYYY) Not Claimed YES NO	Prior Foreign Application										
11/200435	11/200435 11/211148										
Additional foreign application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto:											
I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.											
Application Number(s) Filing Date (MM/DD/YYYY) Additional provisional application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto.											

[Page 1 of 2]4

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	NAME OF SOLE	E OR FIRST IN	VENTOR:	:		A petit	tion has be	en filed	ed for this unsigned inventor		
嗯	Given Name (first and middle [if	any])	Shoji			Family or Surr		O !	ISO'	-	
	Inventor's Signature	Skoji	Oiso	<u>-</u>			<u></u>		Date Noven	Ber. 6, 2001	
¥	Residence: City	Saitam	ıa 了	DV Sta	ate		Country J.	IAPAN	Citizenship	JP	
ı I	Mailing Address 6-8-25-202, Kamiochiai, Yono-shi,										
	Mailing Address	Saitama	338-000)1 JAPAN				· ,			
	_{City} Sai	itama	State			ZIP	338-00)01	Country	JAPAN .	
	NAME OF SECO	OND INVENTO	R:			A peti	tion has be	een filec	d for this uns	signed inventor	
JU	Given Name (first and middle [if	any]) K	umiko			Family or Surn			SHII		
0	Inventor's Signature	Kumike	o Is	shii			·		Date Noves	nber.6.2001	
	Residence: City	Saitan	na.	Sp sta	ate		Country	JAPAN	Citizenship	JP ·	
	Mailing Address	4-10-5, Is	sehara-	cho, Kaw	ragoe	-shi	-,				
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	City Sai	itama	State			ZIP	350-110)8	Country	JAPAN	
I	☐ Additional invento	ors are being name	ed on the	_supplemental A	Additior	nal Inver	ntor(s) sheet	(s) PTO/5	SB/02A attache	ed hereto.	

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Country

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D	ECLARATION				ADDITIONA Suppler Page	L INVEN nental St of/	TOR(S) neet			
Name of Addition	al Joint Inventor, if any		A p	etition	n has been filed	for this un	signed ir	ventor	•	
· . · · · · · · · · · · · · · · · · · ·	ne (first and middle [if any])	- !			Family Nam	e or Surna	me			
	Yoshitaka				KAJIWA	RA				
Inventor's Signature	Yoshitaka	aka Kajiwara Date novembe						november b	200/	
Residence: City	Saitama 500	State	Cou	ıntry	JAPAN.	Citiz	enship	JP _.		
6-8-25-302, Kamiochiai, Yono-shi,										
Post Office Address Saitama 338-0001 JAPAN										
City	Saitama	State	ZI	ء 3	38-0001 _c	ountry	JA1	PAN		
Name of Additional Joint Inventor, if any: A petition has been filed for this unsigned inventor.										
Given Nar	me (first and middle [if any])		_		Family Nam	e or Surna	ime			
Toru TABEI										
inventor's Signature	Tom Ta	bair					Date	Novembe	6,200	
Residence: City	Saitama	State	Cou	untry	JAPAN	CI	tizenship	JP;	<u> </u>	
Post Office Address	8-90-50, Azuma, Kitamoto-shi,									
Post Office Address	Saitama 364-0007 JAPAN									
City	Saitama	State		ZIP	364-0007	Country	J	APAN		
Name of Addition	nal Joint Inventor, if any	:	^A	petitio	n has been filed	for this ur	nsigned i	nventor		
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Inventor's Signature			· · · · · ·				Date			
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State

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DECLARATION — Supplemental Priority Data Sheet

Additional foreign applications:									
Prior Foreign Application Number(s)	Country	Fore	ign Filing Date	Priority Not Claimed	Certified Copy Attached? YES NO				
,									
Additional provisional applications:									
Applic	ation Number		Filing Date (MM/DD/YYYY)						
		i.							
Additional U.S. applicati	ons:								
U.S. Parent Applica Number	tion PCT Parer Number	ıt		iling Date D/YYYY)	Parent Patent Number <i>(if applicable)</i>				
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